

# REALTEK

## RTL8188FTV-VC-CG

### SINGLE-CHIP IEEE 802.11b/g/n 1T1R WLAN

## DATASHEET

(CONFIDENTIAL: Development Partners Only)  
(Draft Version Release)

Rev. 0.2  
27 Dec. 2017  
Track ID:



Realtek Semiconductor Corp.

No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan

Tel.: +886-3-578-0211. Fax: +886-3-577-6047

[www.realtek.com](http://www.realtek.com)

## COPYRIGHT

© 2011 Realtek Semiconductor Corp. All rights reserved. No part of this document may be reproduced, transmitted, transcribed, stored in a retrieval system, or translated into any language in any form or by any means without the written permission of Realtek Semiconductor Corp.

## DISCLAIMER

Realtek provides this document “as is”, without warranty of any kind. Realtek may make improvements and/or changes in this document or in the product described in this document at any time. This document could include technical inaccuracies or typographical errors.

## TRADEMARKS

Realtek is a trademark of Realtek Semiconductor Corporation. Other names mentioned in this document are trademarks/registered trademarks of their respective owners.

## USING THIS DOCUMENT

This document is intended for the software engineer’s reference and provides detailed programming information.

Though every effort has been made to ensure that this document is current and accurate, more information may have become available subsequent to the production of this guide.

## REVISION HISTORY

Revision	Release Date	Summary
0.1	2015/02/04	Preliminary release
0.2	2017/12/27	Modify Model name

## Note:

Datasheet revision / feature will be adjusted and updated continuously by Realtek without further notice.

## Table of Contents

---

<b>1. GENERAL DESCRIPTION</b> .....	<b>1</b>
<b>2. FEATURES</b> .....	<b>3</b>
<b>3. APPLICATION DIAGRAM</b> .....	<b>5</b>
3.1. SINGLE-BAND 11N (1X1) SOLUTION WITH SINGLE ANTENNA .....	5
<b>4. PIN ASSIGNMENTS</b> .....	<b>6</b>
4.1. PACKAGE IDENTIFICATION .....	6
<b>5. PIN DESCRIPTIONS</b> .....	<b>7</b>
5.1. USB BUS TRANSCEIVER INTERFACE.....	7
5.2. POWER PINS .....	7
5.3. RF INTERFACE .....	7
5.4. LED INTERFACE.....	8
5.5. CLOCK AND OTHER PINS .....	9
<b>6. ELECTRICAL AND THERMAL CHARACTERISTICS</b> .....	<b>10</b>
6.1. TEMPERATURE LIMIT RATINGS .....	10
6.2. DC CHARACTERISTICS .....	10
6.2.1. Power Supply Characteristics .....	10
6.2.2. Digital IO Pin DC Characteristics .....	10
<b>7. INTERFACE TIMING SPECIFICATION</b> .....	<b>11</b>
7.1. USB BUS DURING POWER ON SEQUENCE .....	11
<b>8. MECHANICAL DIMENSIONS</b> .....	<b>12</b>
8.1. MECHANICAL DIMENSIONS NOTES.....	12
<b>9. ORDERING INFORMATION</b> .....	<b>13</b>

---

---

## List of Tables

---

TABLE 1. USB BUS TRANSCEIVER INTERFACE .....	7
TABLE 2. POWER PINS .....	7
TABLE 3. RF INTERFACE .....	7
TABLE 4. LED INTERFACE.....	8
TABLE 5. CLOCK AND OTHER PINS .....	9
TABLE 6. TEMPERATURE LIMIT RATINGS .....	10
TABLE 7. DC CHARACTERISTICS .....	10
TABLE 8. 3.3V GPIO DC CHARACTERISTICS.....	10
TABLE 9. THE TYPICAL TIMING RANGE .....	11
TABLE 10. ORDERING INFORMATION .....	13

---

## List of Figures

---

FIGURE 1. SINGLE-BAND 11n (1X1) SOLUTION .....	5
FIGURE 2. PIN ASSIGNMENTS.....	6
FIGURE 3. RTL8188FTV-VC-CG USB BUS POWER ON SEQUENCE .....	11

---

# 1. General Description

The Realtek RTL8188FTV-VC-CG is a highly integrated single-chip 802.11n Wireless LAN (WLAN) network USB interface (USB 1.0/1.1/2.0 compliant) controller. It combines a WLAN MAC, a 1T1R capable WLAN baseband, and WLAN RF in a single chip. The RTL8188FTV-VC-CG provides a complete solution for a high throughput performance integrated wireless LAN device.

The RTL8188FTV-VC-CG WLAN baseband implements Orthogonal Frequency Division Multiplexing (OFDM) with 1 transmit and 1 receive path and is compatible with the IEEE 802.11n specification. Features include one spatial stream transmission, short guard interval (GI) of 400ns, spatial spreading, and transmission over 20MHz and 40MHz bandwidth.

For legacy compatibility, Direct Sequence Spread Spectrum (DSSS), Complementary Code Keying (CCK) and OFDM baseband processing are included to support all IEEE 802.11b and 802.11g data rates. Differential phase shift keying modulation schemes, DBPSK and DQPSK with data scrambling capability, are available, and CCK provides support for legacy data rates, with long or short preamble. The high-speed FFT/IFFT paths, combined with BPSK, QPSK, 16QAM, and 64QAM modulation of the individual subcarriers and rate compatible punctured convolutional coding with coding rate of 1/2, 2/3, 3/4, and 5/6, provide higher data rates of 54Mbps and 150Mbps for IEEE 802.11g and 802.11n OFDM respectively.

The RTL8188FTV-VC-CG WLAN Controller builds in an enhanced signal detector, an adaptive frequency domain equalizer, and a soft-decision Viterbi decoder to alleviate severe multi-path effects and mutual interference in the reception of multiple streams.

Efficient IQ-imbalance, DC offset, phase noise, frequency offset, and timing offset compensations are provided for the radio frequency front-end. Selectable digital transmit and receive FIR filters are provided to meet transmit spectrum mask requirements and to reject adjacent channel interference, respectively.

The RTL8188FTV-VC-CG WLAN Controller supports fast receiver Automatic Gain Control (AGC) with synchronous and asynchronous control loops among antennas, and adaptive transmit power control function to obtain the better performance in the analog portions of the transceiver.

The RTL8188FTV-VC-CG WLAN MAC supports 802.11e for multimedia applications, 802.11i for security, and 802.11n for enhanced MAC protocol efficiency. Using packet aggregation techniques such as

A-MPDU with BA and A-MSDU, protocol efficiency is significantly improved. Power saving mechanisms such as Legacy Power Save, and U-APSD, reduce the power wasted during idle time, and compensates for the extra power required to transmit OFDM. The RTL8188FTV-VC-CG provides simple legacy and 20MHz/40MHz co-existence mechanisms to ensure backward and network compatibility.

## 2. Features

### General

- 24-pin QFN
- CMOS MAC, Baseband PHY, and RF in a single chip for IEEE 802.11b/g/n compatible WLAN
- Complete 802.11n solution for 2.4GHz band
- 72.2Mbps receive PHY rate and 72.2Mbps transmit PHY rate using 20MHz bandwidth
- 150Mbps receive PHY rate and 150Mbps transmit PHY rate using 40MHz bandwidth
- Compatible with 802.11n specification
- Backward compatible with 802.11b/g devices while operating in 802.11n mode
- Power saving mechanism
- Channel management and co-existence
- Transmit Opportunity (TXOP) Short Inter-Frame Space (SIFS) bursting for higher multimedia bandwidth

### Interface

- Complies with USB 1.0/1.1/2.0 for WLAN

### Standards Supported

- IEEE 802.11b/g/n compatible WLAN
- IEEE 802.11e QoS Enhancement (WMM)
- 802.11i (WPA, WPA2). Open, shared key, and pair-wise key authentication services

### WLAN MAC Features

- Frame aggregation for increased MAC efficiency (A-MSDU, A-MPDU)
- Low latency immediate High-Throughput Block Acknowledgement (HT-BA)
- PHY-level spoofing to enhance legacy compatibility

### WLAN PHY Features

- IEEE 802.11n OFDM
- One Transmit and one Receive path (1T1R)
- 20MHz and 40MHz bandwidth transmission
- Short Guard Interval (400ns)
- DSSS with DBPSK and DQPSK, CCK modulation with long and short preamble
- OFDM with BPSK, QPSK, 16QAM, and 64QAM modulation.  
Convolutional Coding Rate: 1/2, 2/3, 3/4, and 5/6
- Maximum data rate 54Mbps in 802.11g and 150Mbps in 802.11n
- Selectable receiver FIR filters
- Programmable scaling in transmitter and receiver to trade quantization noise against increased probability of clipping
- Fast receiver Automatic Gain Control (AGC)
- On-chip ADC and DAC

### Peripheral Interfaces

- General Purpose Input/Output (5 pins)

- One configurable LED pins

Realtek Confidential files  
The document authorized to  
Cdtech  
2018-04-23 10:19:26



### 3. Application Diagram

#### 3.1. Single-Band 11n (1x1) Solution with Single Antenna

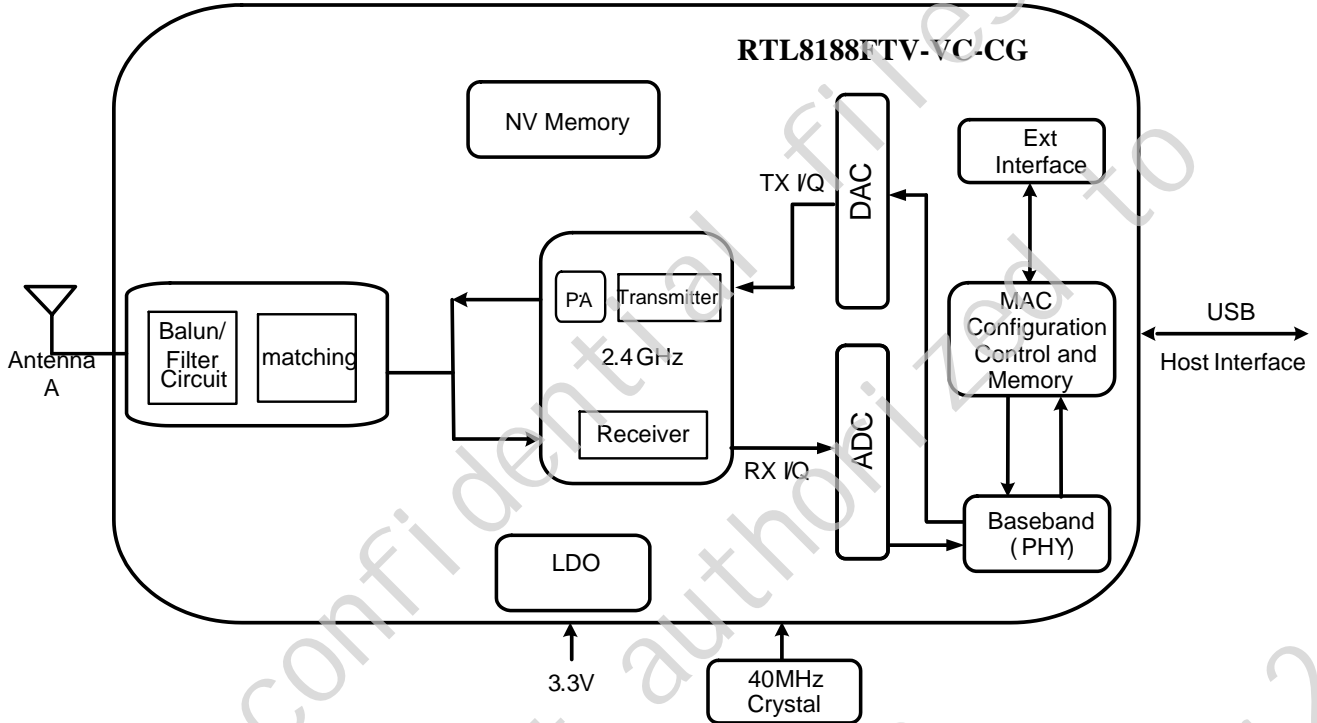


Figure 1. Single-Band 11n (1x1) Solution

## 4. Pin Assignments

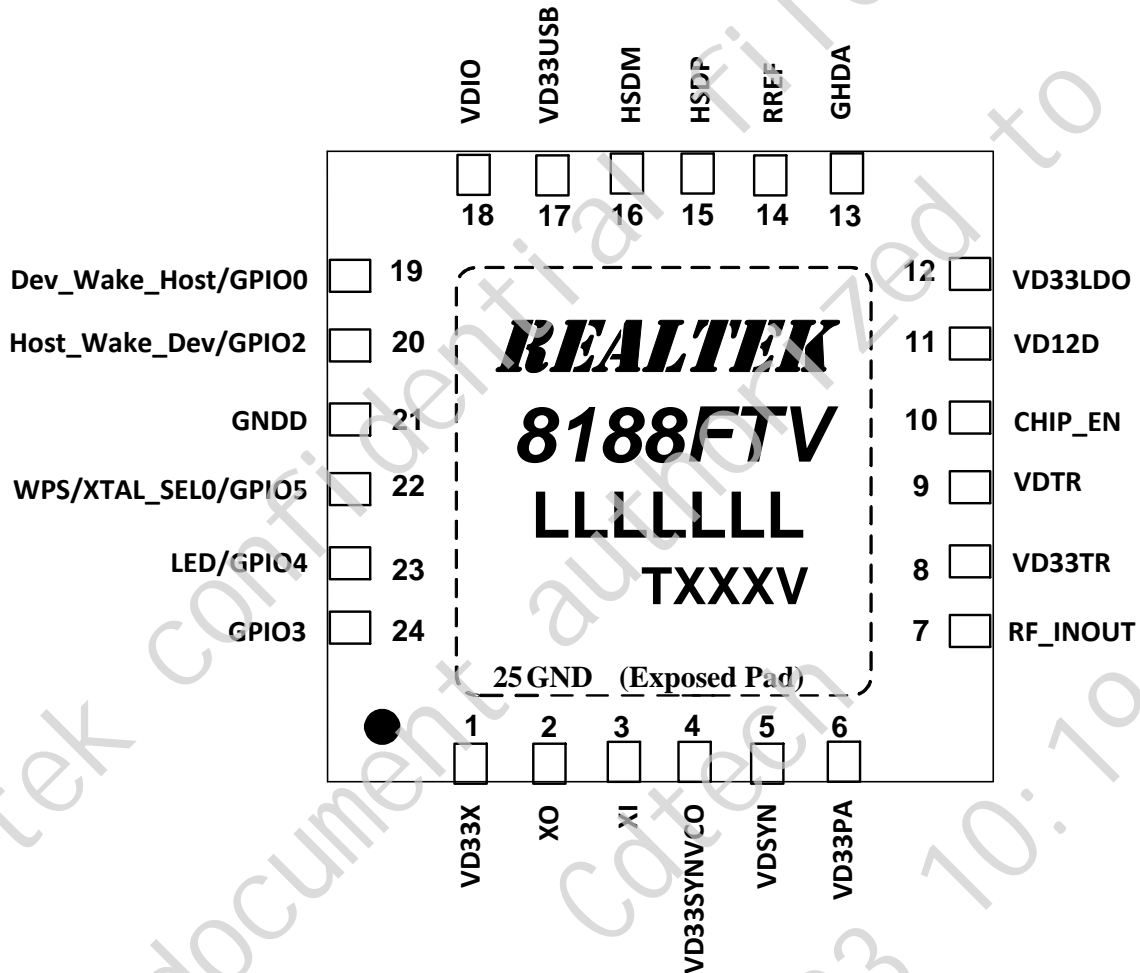


Figure 2 Pin Assignments

### 4.1. Package Identification

‘Green’ package is indicated by a ‘G’ in the location marked ‘T’ in 錯誤! 找不到參照來源。 . The version is shown in the location marked ‘V’, e.g., C=Version C

## 5. Pin Descriptions

The following signal type codes are used in the tables:

I: Input;

O:Output

I/O: bi-directional input/output pin;

P:Power pin

### 5.1. USB Bus Transceiver Interface

**Table 1. USB bus Transceiver Interface**

Symbol	Type	Pin No	Description
HSDM/HSDP	I/O	16/15	USB Receive Differential Pair

### 5.2. Power Pins

**Table 2. Power Pins**

Symbol	Type	Pin No	Description
VD33X	P	1	VDD 3.3V for XTAL
VD33SYNVCO	P	4	VDD 3.3V for Analog
VDSYN	P	5	VDD 3.3V or VDD 1.2v for Analog
VD33PA	P	6	VDD 3.3V for PA
VD33TR	P	8	VDD 3.3V for RF
VDTR	P	9	VDD 3.3V or VDD 1.2v for RF
VD33LDO	P	12	VDD 3.3V for internal LDO
VD33USB	P	17	VDD 3.3V for USB
VDIO	P	18	VDD 3.3V for GPIO
VD12D	P	11	Digital 1.2V for core
GND	P	13,21	Ground

### 5.3. RF Interface

**Table 3. RF Interface**

Symbol	Type	Pin No	Description
RF_INOUT	I/O	7	RF TRX Signal

## 5.4. LED Interface

**Table 4. LED Interface**

Symbol	Type	Pin No	Description
LED/GPIO4	I/O	23	LED Pins (Active Low) Shared with GPIO4

## 5.5. Clock and Other Pins

**Table 5. Clock and Other Pins**

Symbol	Type	Pin No	Description
XI	I	3	25/40MHz OSC Input Input of 25/40MHz Crystal clock reference
XO	O	2	Output of 25/40MHz Crystal Clock Reference
CHIP_EN	I	10	This Pin can Externally Shutdown RTL8188FTV-VC-CG
RREF	O	14	Band gap. It needs to link 24k resistor pull down.
Dev_Wake_Host/GPIO0	I/O	19	Device wake host output pin, Shared with GPIO0
Host_Wake_Dev/GPIO2	I/O	20	Host Wake Device input pin, Shared with GPIO2
WPS/USB_XTAL_SEL0/ GPIO5	I/O	22	Trap Function: Decide to use the 27/40Mhz crystal by this pin power on latch low or high. USB_XTAL_SEL = 1, XTAL frequency is 27MHz USB_XTAL_SEL = 0, XTAL frequency is 40MHz Shared with GPIO5
GPIO3	I/O	24	General Purpose Input/Output Pin

## 6. Electrical and Thermal Characteristics

### 6.1. Temperature Limit Ratings

**Table 6. Temperature Limit Ratings**

Parameter	Minimum	Maximum	Units
Storage Temperature	-55	+125	°C
Ambient Operating Temperature	0	70	°C
Junction Temperature	0	125	°C

### 6.2. DC Characteristics

#### 6.2.1. Power Supply Characteristics

**Table 7. DC Characteristics**

Symbol	Parameter	Minimum	Typical	Maximum	Units
VD33X VD33SYNVCO VDSYN VD33PA VD33TR VDTR VD33LDO VD33USB VDIO	3.3V I/O Supply Voltage	3.0	3.3	3.6	V
VD12D	1.2V Core Supply Voltage	1.10	1.2	1.32	V

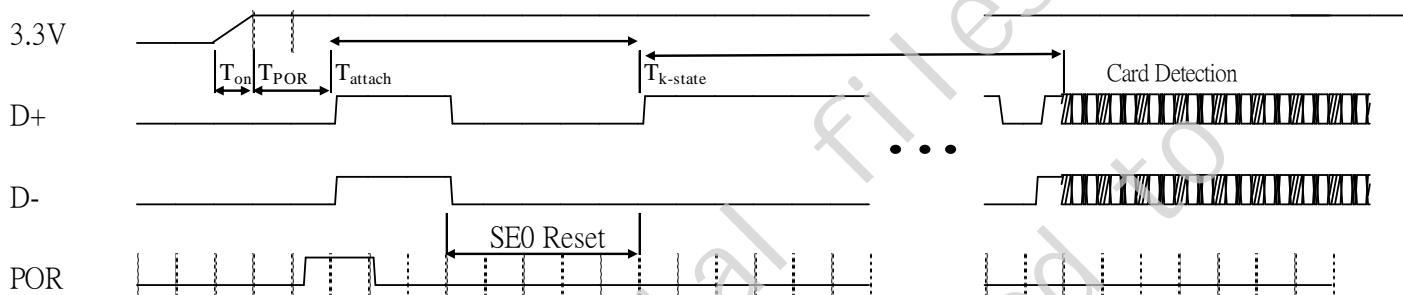
#### 6.2.2. Digital IO Pin DC Characteristics

**Table 8. 3.3V GPIO DC Characteristics**

Symbol	Parameter	Minimum	Normal	Maximum	Units
V <sub>IH</sub>	Input high voltage	2.0	3.3	3.6	V
V <sub>IL</sub>	Input low voltage	--	0	0.9	V
V <sub>OH</sub>	Output high voltage	2.97	--	3.3	V
V <sub>OL</sub>	Output low voltage	0	--	0.33	V

## 7. Interface Timing Specification

### 7.1. USB Bus during Power On Sequence



**Figure 3 RTL8188FTV-VC-CG USB Bus Power On Sequence**

**T<sub>on</sub>**: The main power ramp up duration

**T<sub>por</sub>**: The power on reset releases and power management unit executes power on tasks

**T<sub>attach</sub>**: USB attach state

**T<sub>k-state</sub>**: the duration from resistor attached to USB host starting card detection procedure

**The power on flow description:**

After main 3.3V ramp up, the internal power on reset is released by power ready detection circuit and the power management unit will be enabled. The power management unit enables the internal regulator and clock circuits.

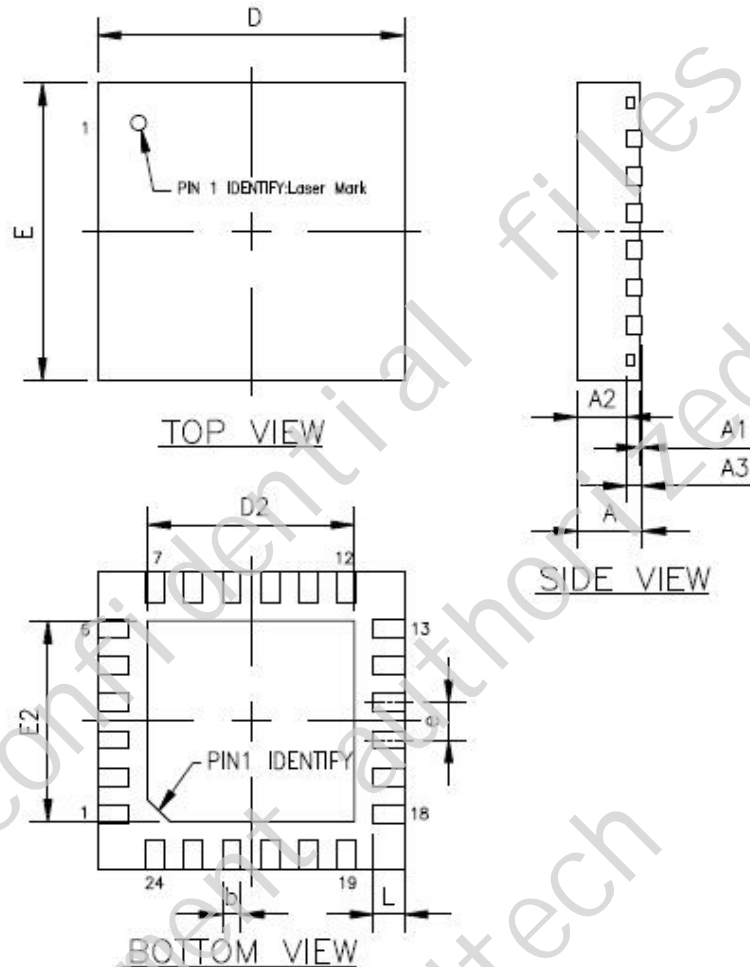
The power management unit also enables the USB circuits.

USB analog circuits attach resistors to indicate the insertion of the USB device

Table 9. The typical timing range

	Unit	Min	Typical	Max
<b>T<sub>on</sub></b>	ms	0.25	1.5	5
<b>T<sub>por</sub></b>	ms	--	2	10
<b>T<sub>attach</sub></b>	ms	2	7	15
<b>T<sub>k-state</sub></b>	ms	50	250	--

## 8. Mechanical Dimensions



### 8.1. Mechanical Dimensions Notes

Symbol	Dimension in mm			Dimension in inch		
	Min	Nom	Max	Min	Nom	Max
A	0.80	0.85	0.90	0.031	0.033	0.035
A1	0.00	0.02	0.05	0.000	0.001	0.002
A2	—	0.65	0.70	—	0.026	0.028
A3	0.20 REF			0.008 REF		
b	0.18	0.25	0.30	0.007	0.010	0.012
D/E	4.00 BSC			0.158 BSC		
D2/E2	2.00	2.20	2.45	0.078	0.087	0.096
e	0.50 BSC			0.020 BSC		
L	0.30	0.40	0.50	0.012	0.016	0.020

Notes :

1. CONTROLLING DIMENSION : MILLIMETER(mm).
2. REFERENCE DOCUMENTL : JEDEC MO-220.



## 9. Ordering Information

**Table 10. Ordering Information**

Part Number	Package	Status
RTL8188FTV-VC-CG	QFN-24, 'Green' Package	Mass Production

---

**Realtek Semiconductor Corp.****Headquarters**

No. 2, Innovation Road II, Hsinchu Science Park,  
Hsinchu 300, Taiwan, R.O.C.

Tel: 886-3-5780211 Fax: 886-3-5776047

[www.realtek.com](http://www.realtek.com)